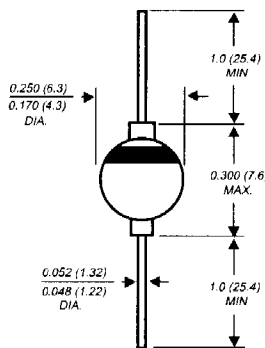


RG3A THRU RG3M

GLASS PASSIVATED FAST SWITCHING RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current - 3.0 Amperes

Case Style G3



Dimensions in inches and (millimeters)

FEATURES

- ◆ High temperature metallurgically bonded construction
- ◆ Glass passivated cavity-free junction
- ◆ Hermetically sealed package
- ◆ 3.0 Ampere operation at $T_A=55^\circ\text{C}$ with no thermal runaway
- ◆ Typical I_R less than $0.1\mu\text{A}$
- ◆ Capable of meeting environmental standards of MIL-S-19500
- ◆ Fast switching for high efficiency
- ◆ High temperature soldering guaranteed: $350^\circ\text{C}/10$ seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension

MECHANICAL DATA

Case: Solid glass body

Terminals: Solder plated axial leads, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.04 ounce, 1.1 grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

	SYMBOLS	RG3A	RG3B	RG3D	RG3G	RG3J	RG3K	RG3M	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	220	400	600	800	1000	Volts
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A=55^\circ\text{C}$	$I_{(AV)}$	3.0							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	100.0							Amps
Maximum instantaneous forward voltage at 3.0A	V_F	1.3							Volts
Maximum average reverse current at rated peak reverse voltage	$I_{R(AV)}$	2.0 100.0							μA
Maximum DC reverse current at rated DC blocking voltage	I_R	5.0							μA
Maximum reverse recovery time (NOTE 1)	t_{rr}	.150				250	400	500	ns
Typical junction capacitance (NOTE 2)	C_J	40.0							pF
Typical thermal resistance (NOTE 3)	$R_{\theta JA}$	22.0							$^\circ\text{C}/\text{W}$
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +175							$^\circ\text{C}$

NOTES:

- (1) Reverse recovery test conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_F=0.25\text{A}$
- (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
- (3) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, with both leads attached to heat sink